

600V 40A APT40DQ60BG APT40DQ60SG

Pb Free Terminal Finish.

ULTRAFAST SOFT RECOVERY RECTIFIER DIODE

PRODUCT APPLICATIONS

- Anti-Parallel Diode -Switchmode Power Supply -Inverters
- Free Wheeling Diode -Motor Controllers -Converters -Inverters
- Snubber Diode

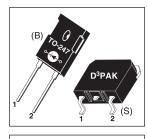
• PFC

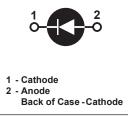
PRODUCT FEATURES

- Ultrafast Recovery Times
- Soft Recovery Characteristics
- · Popular TO-247 Package or Surface Mount D³PAK Package
- Low Forward Voltage
- · Low Leakage Current
- Avalanche Energy Rated

PRODUCT BENEFITS

- Low Losses
- · Low Noise Switching
- Cooler Operation
- · Higher Reliability Systems
- Increased System Power Density





MAXIMUM RATINGS

All Ratings: $T_{C} = 25^{\circ}C$ unless otherwise specified. APT40DQ60(B/S)G **Characteristic / Test Conditions** UNIT Symbol V_{R} Maximum D.C. Reverse Voltage V_{RRM} Maximum Peak Repetitive Reverse Voltage 600 Volts V_{RWM} Maximum Working Peak Reverse Voltage Maximum Average Forward Current ($T_{C} = 111^{\circ}C$, Duty Cycle = 0.5) 40 I_{F(AV)} RMS Forward Current (Square wave, 50% duty) 63 Amps I_{F(RMS)} Non-Repetitive Forward Surge Current ($T_1 = 45^{\circ}C$, 8.3ms) I_{FSM} 320 Avalanche Energy (1A, 40mH) 20 mJ EAVL T_J,T_{STG} -55 to 175 Operating and StorageTemperature Range °C TL 300 Lead Temperature for 10 Sec.

STATIC ELECTRICAL CHARACTERISTICS

| Symbol | Characteristic / Test Conditions | | MIN | ТҮР | MAX | UNIT |
|-----------------|---|---|-----|-----|-----|-------|
| V _F | Forward Voltage | I _F = 40A | | 2.0 | 2.4 | Volts |
| | | I _F = 80A | | 2.5 | | |
| | | I _F = 40A, T _J = 125°C | | 1.7 | | |
| I _{RM} | Maximum Reverse Leakage Current | V _R = 600V | | | 25 | μA |
| | | V _R = 600V, T _J = 125°C | | | 500 | |
| C _T | Junction Capacitance, V _R = 200V | | | 36 | | pF |

DYNAMIC CHARACTERISTICS

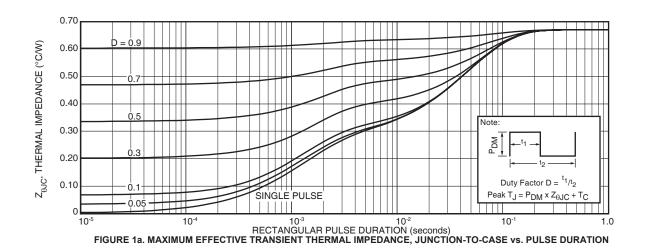
APT40DQ60(B/S)G

| Symbol | Characteristic | Test Conditions | MIN | ТҮР | MAX | UNIT |
|------------------|--|--|-----|-----|-----|------|
| t _{rr} | Reverse Recovery Time $I_F = 1A$, $di_F/dt = -100A/\mu s$, $V_R = 30V$, $T_J = 25^{\circ}C$ | | - | 22 | | 20 |
| t _{rr} | Reverse Recovery Time | I _F = 40A, di _F /dt = -200A/μs V _R = 400V, T _C = 25°C | - | 25 | | ns |
| Q _{rr} | Reverse Recovery Charge | | - | 35 | | nC |
| I _{RRM} | Maximum Reverse Recovery Current | | - | 3 | - | Amps |
| t _{rr} | Reverse Recovery Time | I _F = 40A, di _F /dt = -200A/μs V _R = 400V, T _C = 125°C | - | 160 | | ns |
| Q _{rr} | Reverse Recovery Charge | | - | 480 | | nC |
| I _{RRM} | Maximum Reverse Recovery Current | | - | 6 | - | Amps |
| t _{rr} | Reverse Recovery Time | I _F = 40A, di _F /dt = -1000A/µs V _R = 400V, T _C = 125°C | - | 85 | | ns |
| Q _{rr} | Reverse Recovery Charge | | - | 920 | | nC |
| I _{RRM} | Maximum Reverse Recovery Current | | - | 20 | | Amps |

THERMAL AND MECHANICAL CHARACTERISTICS

| Symbol | Characteristic / Test Conditions | MIN | ТҮР | MAX | UNIT |
|------------------------|-------------------------------------|-----|------|-----|-------|
| $R_{_{	ext{	heta}JC}}$ | Junction-to-Case Thermal Resistance | | | .67 | °C/W |
| W _T | Package Weight | | 0.22 | | oz |
| | | | 5.9 | | g |
| Torque | Maximum Mounting Torque | | | 10 | lb∙in |
| | | | | 1.1 | N∙m |

APT Reserves the right to change, without notice, the specifications and information contained herein.



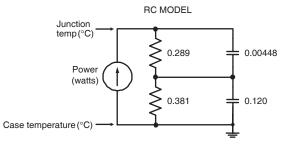
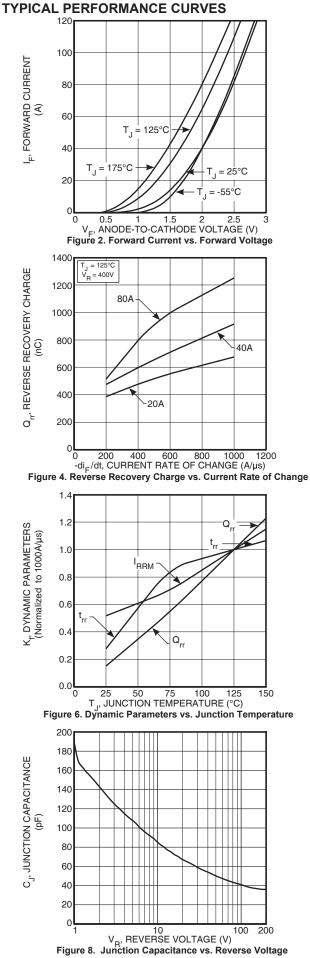
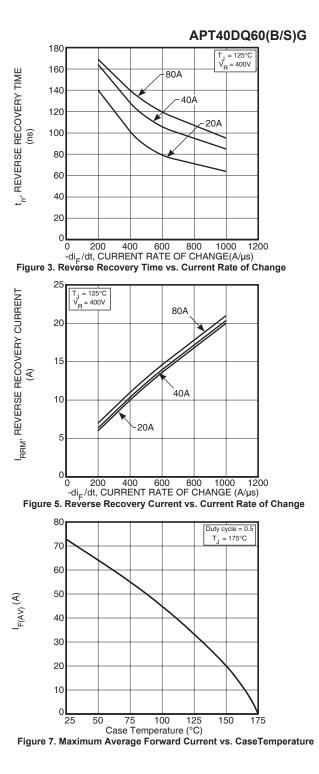


FIGURE 1b, TRANSIENT THERMAL IMPEDANCE MODEL





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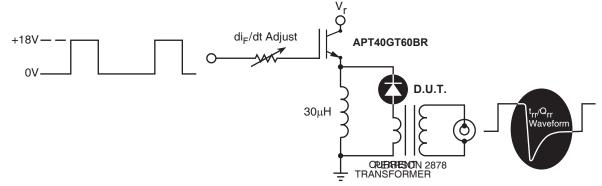


Figure 9. Diode Test Circuit

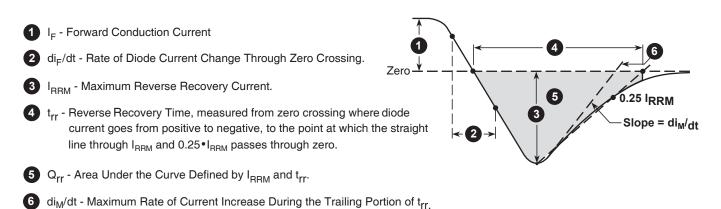
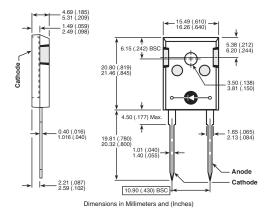
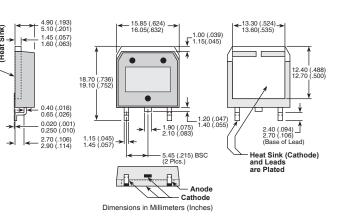


Figure 10, Diode Reverse Recovery Waveform and Definitions



TO-247 Package Outline

D³PAK Package Outline (3) 100% Sn





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